

FORM PTO-1595 (Modified)
(Rev. 03-01)
OMB No. 0651-0027 (exp.5/31/2002)
P08A/REV03

01-02-2004



SHEET

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

Y

Tab settings

102710901

To the Director of the United States Patent and Trademark Office: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):
Gi Hong Kim and Sun Hyoung Lee
3-25-04
Additional names(s) of conveying party(ies) Yes No

2. Name and address of receiving party(ies):
Name: **SILICON7 INC.**
Address: **KEB Bldg. 7F**
358-1 Yatap-dong, Bundang-gu
City: **Seongnam-si** State/Prov.: **Gyeonggi-do**
Country: **KOREA** ZIP: _____
Additional name(s) & address(es) Yes No



3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____
Execution Date: **March 5, 2004**

4. Application number(s) or patent numbers(s): *10810749*
If this document is being filed together with a new application, the execution date of the application is: **March 5, 2004**
Patent Application No. _____ Filing date _____
Additional numbers Yes No

B. Patent No.(s) _____
 Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: **Jae Y. Park**
Registration No. **PLEASE SEE ATTACHED**
Address: **Cantor Colburn LLP**
55 Griffin Road South
04/01/2004 DBYRNE 00000077 10810749
01 FC:8021 40.00 OP
City: **Bloomfield** State/Prov.: **CT**
Country: **USA** ZIP: **06002**

6. Total number of applications and patents involved: **1**
7. Total fee (37 CFR 3.41):.....\$ **40.00**
 Enclosed - Any excess or insufficiency should be credited or debited to deposit account
 Authorized to be charged to deposit account
8. Deposit account number: **06-1130**
(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
Jae Y. Park *Jae Y. Park* **March 25, 2004**
Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and **3**

Mail documents to be recorded with required cover sheet information to:
Mail Stop Assignment Recordation Services
Director of the United States Patent and Trademark Office
P.O. Box 1450, Alexandria, VA 22313-1450

ASSIGNMENT

WHEREAS We, **Gi Hong KIM** of **Halla Apt. 639-801, 919 Jeongja-dong, Jangan-gu, Suwon-si, Gyeonggi-do, Korea** and **Sun Hyoung LEE** of **Kangnam Apt. 8-814, Sillim-dong, Gwanak-gu, Seoul, Korea** (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

SRAM-COMPATIBLE MEMORY DEVICE HAVING THREE SENSE AMPLIFIERS BETWEEN TWO MEMORY BLOCKS

which claims priority to **Korea** Application No. 10-2003-0033059, filed 23/05/2003, and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, **SILICON7 INC.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of **KOREA**, having a place of business at **KEB Bldg. 7F, 358-1 Yatap-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, Korea**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will,

at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 3.5.2004

Gi Hong Kim L.S.
Gi Hong KIM

Date: 3.5.2004

Sun Hyung Lee L.S.
Sun Hyoung LEE